

SiC Diode

Features

- Revolutionary semiconductor material Silicon Carbide
- No reverse recovery current / no forward recovery
- Temperature independent switching behaviour
- Low forward voltage even at high operating temperature
- Tight forward voltage distribution
- Excellent thermal performance
- Extended surge current capability
- Specified dv/dt ruggedness
- Pb-free lead plating; RoHS compliant





Pin 1 and backside: Cathode Pin 2: Anode



Potential applications

- Drives
- Industrial power supplies: Industrial UPS
- Solar central inverters and Solar string inverter

Product validation

Qualified for industrial applications according to the relevant tests of JEDEC 47/20/22

Description

- System efficiency improvement over Si diodes
- Enabling higher frequency / increased power density solutions
- System size/cost savings due to reduced heatsink requirements and smaller magnetics
- Reduced EMI
- Highest efficiency across the entire load range
- Robust diode operation during surge events
- High reliability
- Related Links: www.infineon.com/SiC







PB

Key performance parameters

Туре	V _{DC}	I _F	Q c	$ au_{ m vj,max}$	Marking	Package
IDK05G120C5	1200 V	5 A	24nC	175°C	D0512C5	PG-T0263-2



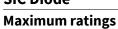




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1 Maximum ratings

Note:

For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

Parameter	Symbol	Value	Unit	
Repetitive peak reverse voltage	$V_{ m RRM}$	1200	V	
<i>T</i> _C ≥ 25°C				
Continuous forward current for $R_{\text{th(j-c,max)}}$				
$T_{\rm C} = 161^{\circ}{\rm C}, {\rm D}{=}1$	l _F	5.0	А	
$T_{\rm C} = 135^{\circ}{\rm C}, {\rm D}{=}1$	I I F	9.2	A	
$T_{\rm C} = 25^{\circ}{\rm C}, {\rm D}{=}1$		19.1		
Surge repetitive forward current, sine halfwave ¹				
T_c =25°C, t_p =10ms		20	Α	
$T_{\rm C}$ =100°C, t _p =10ms	$I_{F,RM}$	15		
Surge non-repetitive forward current, sine halfwave				
T_{c} =25°C, t_{p} =10ms	$I_{F,SM}$	59	А	
$T_{\rm C}$ =150°C, t _p =10ms		50		
Non-repetitive peak forward current		472	٨	
$T_{\rm C} = 25$ °C, $t_{\rm p} = 10 \ \mu {\rm s}$	$I_{F,max}$	472	А	
i²t value				
$T_{\rm C} = 25$ °C, $t_{\rm p} = 10$ ms	∫i²dt	17.4	A ² s	
$T_{\rm C} = 150$ °C, $t_{\rm p} = 10$ ms		12.5		
Diode dv/dt ruggedness	d. /d4	150	M/	
V _R =0960 V	dv/dt	150	V/ns	
Power dissipation for R _{th(j-c,max)}		100		
<i>T</i> _c = 25°C	P_{tot}	109	W	

2021-07-14

¹ Not subject to production test. The test was performed with 20000 pulses (two consecutive half-wave rectified sines with 10 ms period).



Maximum ratings

Operating temperature	$T_{ m vj}$	-55175	°C
Storage temperature	T_{stg}	-55150	°C
Soldering temperature, reflow soldering (MSL1 according to JEDEC J-STD-020)	T_{sold}	260	°C



Thermal resistances

2 Thermal resistances

Davamakay	Symbol	Conditions	Value			
Parameter			min.	typ.	max.	Unit
Characteristic						
Diode thermal resistance, junction – case	$R_{th(j-c)}$		-	1.06	1.37	K/W
Thermal resistance, junction – ambient	$R_{\text{th(j-a)}}$	Leaded	-	-	62	K/W

Electrical Characteristics



3 Electrical Characteristics

Static Characteristics, at $T_{\nu j}$ =25°C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
Parameter			min.	typ.	max.	Oiiit
DC blocking voltage	V _{DC}	$T_{\rm vj} = 25^{\circ}\text{C}, I_{\rm R} = 50 \mu\text{A}$	1200	-	-	V
Diode forward voltage	1/	I_{F} = 5A, T_{vj} =25°C	-	1.50	1.8	V
	V_{F}	$I_F = 5A, T_{Vj} = 25^{\circ}C$ $I_F = 5A, T_{Vj} = 150^{\circ}C$	-	1.95	-	
Reverse current	,	V _R =1200V, T _{vj} =25°C	-	2.5	33	μА
	I _R	V _R =1200V, T _{vj} =150°C	-	12	-	

Dynamic Characteristics, at T_{vj} =25°C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
Parameter			min.	typ.	max.	Oilit
Total capacitive charge		$V_R = 800V, T_{vj} = 150$ °C				
	Qc	$Q_C = \int_0^{V_R} C(V) dV$	-	24	-	nC
		<i>V</i> _R =1 V, <i>f</i> =1 MHz	-	301	-	
Total Capacitance	С	V _R =400 V, <i>f</i> =1 MHz	-	21	-	pF
		V _R =800 V, <i>f</i> =1 MHz	-	17	-	

Electrical Characteristics Diagrams



4 Electrical Characteristics Diagrams

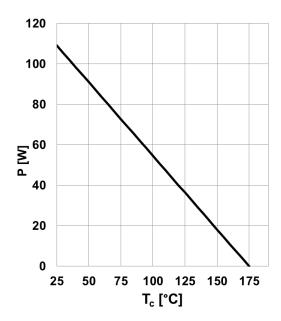


Figure 1. Power dissipation as function of case temperature, $P_{tot}=f(T_c)$, $R_{th(j-c),max}$

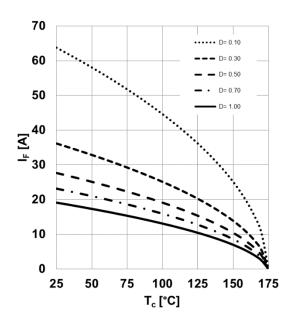


Figure 2. Diode forward current as function of temperature, parameter: $T_{vj} \le 175^{\circ}\text{C}$, $R_{th(j-c),max}$, D = duty cycle, V_{th} , R_{diff} @ $T_{vj} = 175^{\circ}\text{C}$

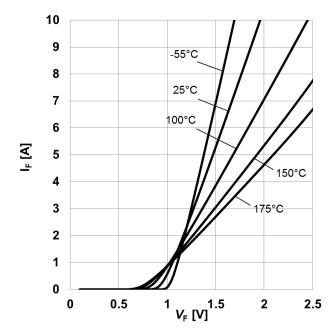


Figure 3. Typical forward characteristics, $I_F = f(V_F)$, $t_p = 10 \mu s$, parameter: T_{vj}

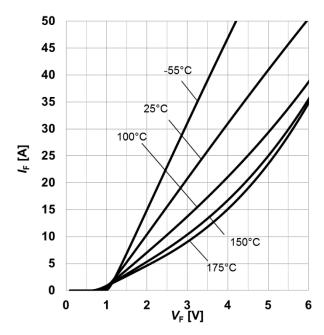


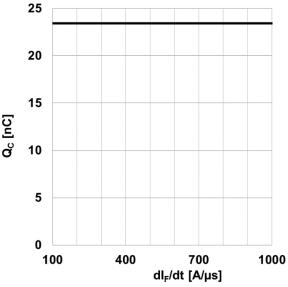
Figure 4. Typical forward characteristics in surge current, $I_F=f(V_F)$, $t_p=10 \mu s$, parameter: T_{vj}

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*T*_{vj}=150°C

Electrical Characteristics Diagrams





100 400 700 1000 dl_F/dt [A/ μ s]

Figure 5. Typical capacitive charge as function of current slope, $Q_c=f(dIF/dt)$.

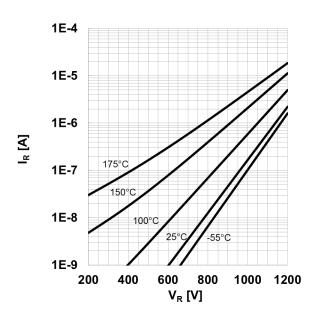


Figure 6. Typical reverse characteristics, $I_R=f(V_R)$, parameter: T_{vj}

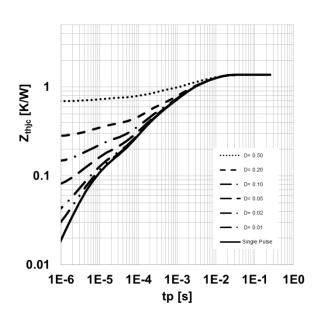


Figure 7. Max. transient thermal impedance, $Z_{th,j-c} = f(t_P)$, parameter: $D = t_P/T$

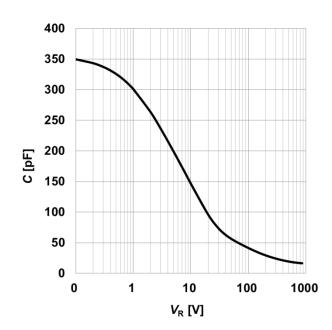


Figure 8. Typical capacitance as function of reverse voltage, $C=f(V_R)$; $T_{vj}=25^{\circ}C$; f=1 MHz



Electrical Characteristics Diagrams

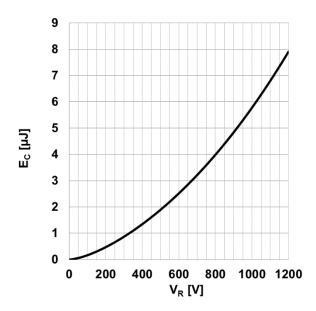


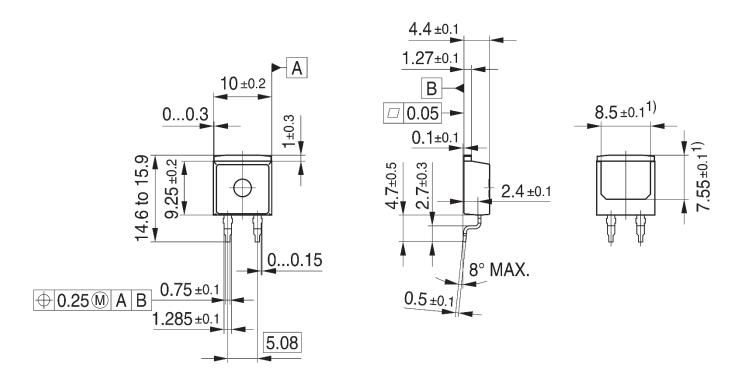
Figure 9. Typical capacitively stored energy as function of reverse voltage, $E_c=f(V_R)$

Package Drawing



Package Drawing 5

PG-TO263-2



1) Typical

Metal surface min. X = 7.25, y = 6.9

All metal surfaces: tin plated, except area of cut

All dimensions do not include mold flash or protrusions

All dimensions are in units mm

The drawings is in complicance with ISO 128-30, Projection Method 1 [←♦]

SiC-Diode

Revision history



Revision history

Document version	Date of release	Description of changes
V 2.0	2019-10-28	Final Datasheet
V 2.1	2021-07-14	Increased dv/dt ruggedness

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